

QUAD 2-INPUT SCHMITT NAND GATE

- HIGH SPEED
 - $t_{PD} = 11 \text{ ns} (TYP.) AT V_{CC} = 5 \text{ V}$
- LOW POWER DISSIPATION $I_{CC} = 1\mu A \text{ (MAX.) AT } T_A = 25 \text{ °C}$
- OUTPUT DRIVE CAPABILITY 10 LSTTL LOADS
- HIGH NOISE IMMUNITY V_H (TYP.) = 0.9 V AT V_{CC} = 5 V
- SYMMETRICAL OUTPUT IMPEDANCE | IOH | = IOL = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS

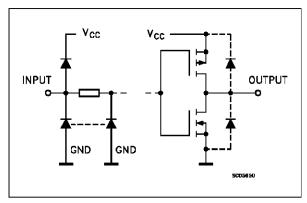
 tplh = tphl
- WIDE OPERATING VOLTAGE RANGE Vcc (OPR) = 2 V TO 6 V
- PIN AND FUNCTION COMPATIBLE WITH 54/74LS132

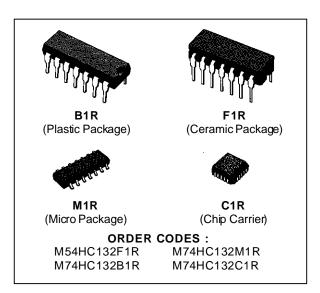
DESCRIPTION

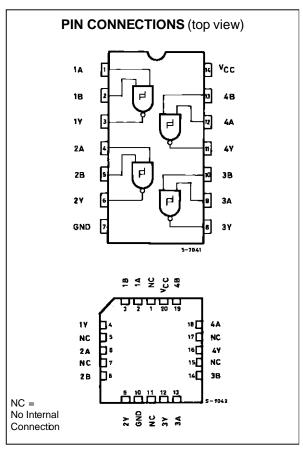
The M54/74HC132 is a high speed CMOS QUAD 2-INPUT SCHMITT NAND GATE fabricated in silicon gate C²MOS technology. It has the same high speed performance of LSTTL combined with true CMOS low power consumption. Pin configuration and function are identical to those of the M54/74HC00.

The hysterisis characteristics (around 20 % V_{CC}) of all inputs allow slowly changing input signals to be transformed into sharply defined jitter-free output signals. All inputs are equipped with protection circuits against static discharge and transient excess voltage.

INPUT AND OUTPUT EQUIVALENT CIRCUIT







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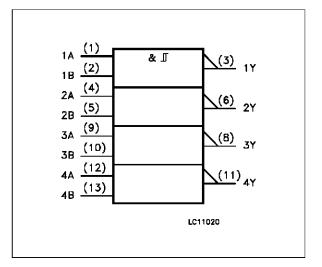
TRUTH TABLE

Α	В	Y
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

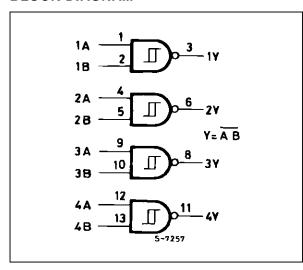
PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1, 4, 9, 12	1A to 4A	Data Inputs
2, 5, 10, 13	1B to 4B	Data Inputs
3, 6, 8, 11	1Y to 4Y	Data Outputs
7	GND	Ground (0V)
14	V _{CC}	Positive Supply Voltage

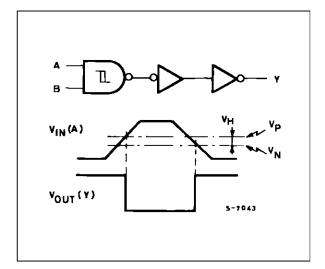
IEC LOGIC SYMBOL



BLOCK DIAGRAM



LOGIC DIAGRAM/WAVEFORM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	-0.5 to +7	V
VI	DC Input Voltage	-0.5 to V _{CC} + 0.5	V
Vo	DC Output Voltage	-0.5 to V _{CC} + 0.5	V
lıĸ	DC Input Diode Current	± 20	mA
I _{OK}	DC Output Diode Current	± 20	mA
lo	DC Output Source Sink Current Per Output Pin	± 25	mA
Icc or I _{GND}	DC V _{CC} or Ground Current	± 50	mA
P_{D}	Power Dissipation	500 (*)	mW
T _{stg}	Storage Temperature	-65 to +150	O°
TL	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied. (*) 500 mW: ≡ 65 °C derate to 300 mW by 10mW/°C: 65 °C to 85 °C



RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	2 to 6	V
VI	Input Voltage	0 to V _{CC}	V
Vo	Output Voltage	0 to V _{CC}	V
T _{op}	Operating Temperature: M54HC Series M74HC Series	-55 to +125 -40 to +85	ဂိဂိ
t _r , t _f	Input Rise and Fall Time	No Limits	

DC SPECIFICATIONS

		Te	est Co	nditions	Value							
Symbol Parameter		V _{CC}				$T_A = 25$ °C 54HC and 74HC		1	85 °C HC	-55 to 125 °C 54HC		Unit
		()			Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
V_P	High Level	2.0			1.0	1.25	1.5	1.0	1.5	1.0	1.5	
	Threshold	4.5			2.3	2.7	3.15	2.3	3.15	2.3	3.15	V
	Voltage	6.0			3.0	3.5	4.2	3.0	4.2	3.0	4.2	
V_N	Low Level	2.0			0.3	0.65	0.9	0.3	0.9	0.3	0.9	
	Threshold	4.5			1.13	1.6	2.0	1.13	2.0	1.13	2.0	V
	Voltage	6.0			1.5	2.3	2.6	1.5	2.6	1.5	2.6	
V_{H}	Hysteresis	2.0			0.3	0.6	1.0	0.3	1.0	0.3	1.0	
	Voltage	4.5			0.6	1.1	1.4	0.6	1.4	0.6	1.4	V
		6.0			8.0	1.2	1.4	0.8	1.7	0.8	1.7	
V _{OH}	High Level	2.0	V _I =		1.9	2.0		1.9		1.9		
	Output Voltage	4.5	V _{IH}		4.4	4.5		4.4		4.4		.,
		6.0	or		5.9	6.0		5.9		5.9		V
		4.5	VIL	I _O =-4.0 mA	4.18	4.31		4.13		4.10		
		6.0		I _O =-5.2 mA	5.68	5.8		5.63		5.60		
Vol	Low Level Output	2.0	Vı =			0.0	0.1		0.1		0.1	
	Voltage	4.5	VIH	I ₀ = 20 μA		0.0	0.1		0.1		0.1	.,
		6.0	or			0.0	0.1		0.1		0.1	V
		4.5	VIL	I _O = 4.0 mA		0.17	0.26		0.33		0.40	
		6.0		I _O = 5.2 mA		0.18	0.26		0.33		0.40	
II	Input Leakage Current	6.0	V _I = V _{CC} or GND				±0.1		±1		±1	μА
Icc	Quiescent Supply Current	6.0	Vı = '	Vcc or GND			1		10		20	μА

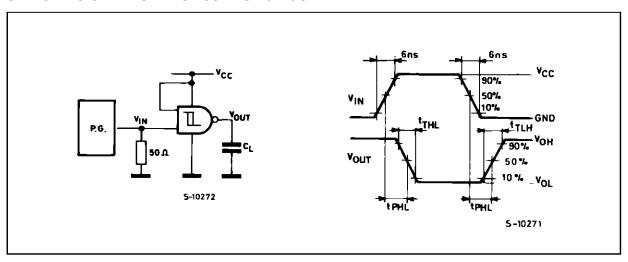


AC ELECTRICAL CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

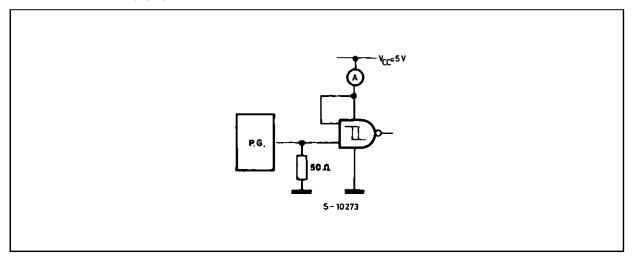
		Test Condition	ns	Value						
Symbol Parameter	Vcc		T _A = 25 °C 54HC and 74HC			-40 to 85 °C 74HC		-55 to 125 °C 54HC		
		(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t _{TLH}	Output Transition	2.0		30	75		95		110	
t_{THL}	Time	4.5		8	15		19		22	ns
		6.0		7	13		16		19	
t _{PLH}	Propagation	2.0		52	105		130		160	
t_{PHL}	Delay Time	4.5		13	21		26		32	ns
		6.0		11	18		22		27	
C _{IN}	Input Capacitance			5	10		10		10	pF
C _{PD} (*)	Power Dissipation Capacitance			29						pF

^(*) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operting current can be obtained by the following equation. $I_{CC}(opr) = C_{PD} \bullet V_{CC} \bullet f_{IN} + I_{CC}/4$ (per Gate)

SWITCHING CHARACTERISTICS TEST CIRCUIT

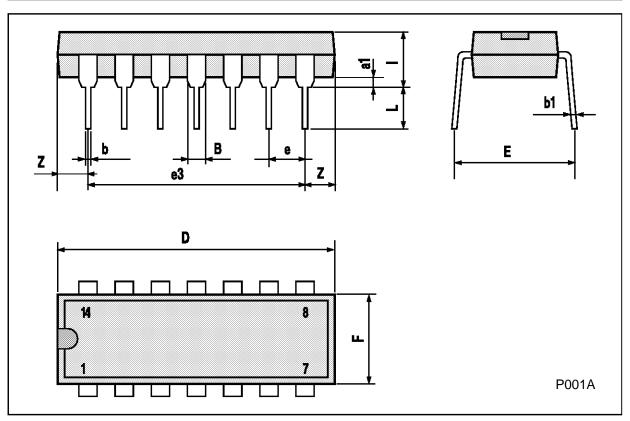


TEST CIRCUIT Icc (Opr.)



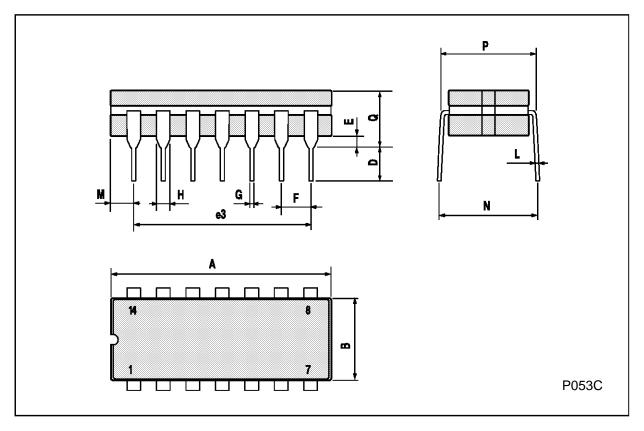
Plastic DIP14 MECHANICAL DATA

DIM.		mm		inch			
Divi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
a1	0.51			0.020			
В	1.39		1.65	0.055		0.065	
b		0.5			0.020		
b1		0.25			0.010		
D			20			0.787	
E		8.5			0.335		
е		2.54			0.100		
e3		15.24			0.600		
F			7.1			0.280	
I			5.1			0.201	
L		3.3			0.130		
Z	1.27		2.54	0.050		0.100	



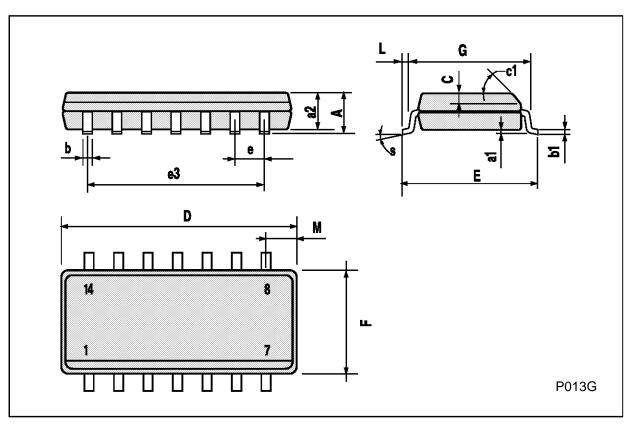
Ceramic DIP14/1 MECHANICAL DATA

DIM.		mm		inch			
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α			20			0.787	
В			7.0			0.276	
D		3.3			0.130		
E	0.38			0.015			
e3		15.24			0.600		
F	2.29		2.79	0.090		0.110	
G	0.4		0.55	0.016		0.022	
Н	1.17		1.52	0.046		0.060	
L	0.22		0.31	0.009		0.012	
M	1.52		2.54	0.060		0.100	
N			10.3			0.406	
Р	7.8		8.05	0.307		0.317	
Q			5.08			0.200	



SO14 MECHANICAL DATA

DIM.		mm		inch				
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А			1.75			0.068		
a1	0.1		0.2	0.003		0.007		
a2			1.65			0.064		
b	0.35		0.46	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.019			
c1			45°	(typ.)				
D	8.55		8.75	0.336		0.344		
Е	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		7.62			0.300			
F	3.8		4.0	0.149		0.157		
G	4.6		5.3	0.181		0.208		
L	0.5		1.27	0.019		0.050		
М			0.68			0.026		
S			8° (ı	max.)				



PLCC20 MECHANICAL DATA

DIM.		mm		inch				
J	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	9.78		10.03	0.385		0.395		
В	8.89		9.04	0.350		0.356		
D	4.2		4.57	0.165		0.180		
d1		2.54			0.100			
d2		0.56			0.022			
E	7.37		8.38	0.290		0.330		
е		1.27			0.050			
e3		5.08			0.200			
F		0.38			0.015			
G			0.101			0.004		
М		1.27			0.050			
M1		1.14			0.045			



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